

# SEU WORKING GROUP

## GOALS

Define Level and Types of SEE Problems

Appropriate Mitigation

What's already done

needs Study

Provide Repository for Results

TWEPP 2010

# Mitigation of Single Event Effects

## SEE Domains

- ASIC Design → Today's topic
- FPGA Design → J. Christiansen announcement

Determine Mitigation requirements

Acceptable rates of

- Compromised of functional fidelity
- Loss of data integrity

What Level of mitigation is required?

Which ASIC Technology ?

# Presentations / Conclusions

- ▣ Three presentations:
  - Federico Faccio (CERN)
  - Sandro Bonichi (CERN)
    - ▣ Work at CERN in 130nm
  - Moshine Menouni (CPPM)
    - ▣ FEI4 mitigation approach (some cells without mitigation to help calibrate effectiveness)
- ▣ Web Archive of work, meetings, issues to be made available to the community.

# CERN-PH/ESE

## F.Faccio, S.Bonacini

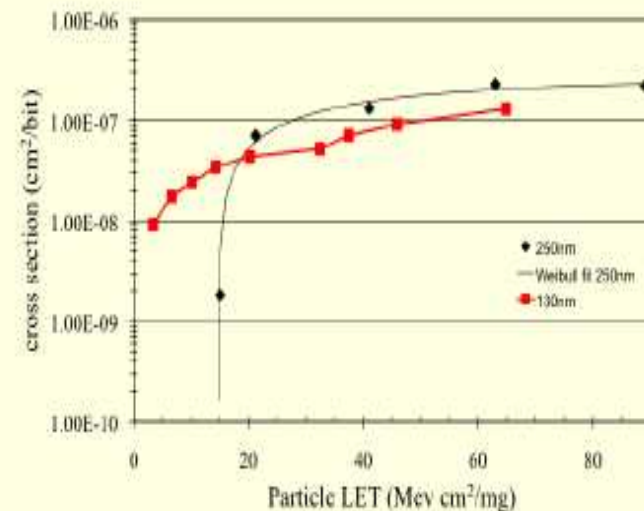
### Available radiation data for “hardened” cells (proton tests)

- Wide range of “hardened” cells custom designed and tested (200MeV protons) by FNAL. Results presented by J.Hoff in 2006.
  - Some of them have cross-section 3 orders of magnitude below the one measured for a commercial cell
- DICE cells custom designed and tested in 2008 by the ATLAS Pixel detector collaboration
  - results presented by M.Menouni at TWEPP 08
  - 3 different layouts integrated
  - Tests done with the CERN 24 GeV/c proton beam
  - Cross-section varies with layout but mainly around  $2\text{-}3 \cdot 10^{-18} \text{ cm}^2/\text{bit}^{-1}$ .
    - This is 10 times larger than what measured by FNAL on the same design in 2008
    - (but different layout and proton energy).

Type	Cross Section
LBL Dice	$3.84 \cdot 10^{-17} \text{ cm}^2/\text{bit}$
RT Dice	$5.86 \cdot 10^{-17} \text{ cm}^2/\text{bit}$
RT Seuss	$1.03 \cdot 10^{-15} \text{ cm}^2/\text{bit}$
RT SR-ff	$3.85 \cdot 10^{-14} \text{ cm}^2/\text{bit}$
RT normal	$3.23 \cdot 10^{-14} \text{ cm}^2/\text{bit}$
TR Seuss	$4.7 \cdot 10^{-15} \text{ cm}^2/\text{bit}$
TR SR-ff	$8.91 \cdot 10^{-15} \text{ cm}^2/\text{bit}$
Hit	$1.50 \cdot 10^{-15} \text{ cm}^2/\text{bit}$
Liu	$2.80 \cdot 10^{-16} \text{ cm}^2/\text{bit}$
Dice	$4.55 \cdot 10^{-15} \text{ cm}^2/\text{bit}$
Seuss	$1.05 \cdot 10^{-14} \text{ cm}^2/\text{bit}$
SR-ff	$5.02 \cdot 10^{-14} \text{ cm}^2/\text{bit}$
COMMERCIAL	$4.86 \cdot 10^{-14} \text{ cm}^2/\text{bit}$
Normal	$5.83 \cdot 10^{-14} \text{ cm}^2/\text{bit}$

### Comparison with 250nm FF

- Comparison with 0.25 $\mu\text{m}$  FF (using ELTs):
  - Cross-section of the commercial 130nm design orders of magnitude larger in LHC environment – the 0.25 $\mu\text{m}$  design had a threshold close to the maximum LET possible from nuclear interaction in Si

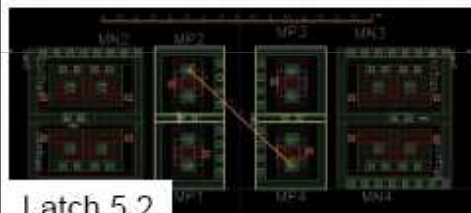


# CPPM-CNRS (Moshine Menouni)

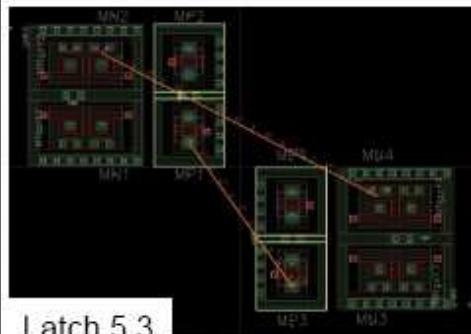
## Layouts implemented in the chip SEU2



Latch 5



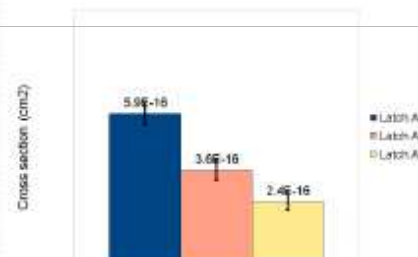
Latch 5.2



Latch 5.3

Latch type	area	Cross section cm <sup>2</sup> /bit		
		1->0	0->1	1->0 and 0->1 (*)
Latch 5	48 μm <sup>2</sup>	(1.5 0.1).10 <sup>-16</sup>	(2.2 0.3).10 <sup>-16</sup>	(5.9 0.5).10 <sup>-16</sup>
Latch 5.2	48 μm <sup>2</sup>	(3.4 0.6).10 <sup>-16</sup>	(4.2 0.4).10 <sup>-16</sup>	(3.6 0.5).10 <sup>-16</sup>
Latch 5.3	48 μm <sup>2</sup>	(3.0 0.6).10 <sup>-16</sup>	(3.3 0.3).10 <sup>-16</sup>	(2.4 0.5).10 <sup>-16</sup>

Cross section for '0101...01' pattern



Measurements made in 2008  
for the chip SEU2.

- Different layout versions were implemented in the SEU2 chip
  - Same schematic but different layout
- The latch 5.3 is 2.5 times tolerant to SEU than the latch 5
- This result shows the importance of separating sensitive nodes